

Maximum Ratings @TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P _{PP}	130	W	8/20μs, Per Fig. 1
Peak Pulse Current	I _{PP}	12	Α	8/20μs, Per Fig. 1
ESD Protection – Contact Discharge	V _{ESD_Contact}	±30	kV	IEC 61000-4-2 Standard
ESD Protection – Air Discharge	V_{ESD_Air}	±30	kV	IEC 61000-4-2 Standard

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	P_{D}	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	$R_{ hetaJA}$	500	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

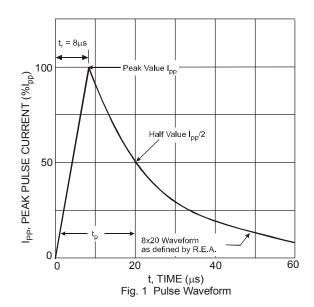
Electrical Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Standoff Voltage	V _{RWM}	-	-	5	V	-
Channel Leakage Current (Note 6)	I _{RM}	-	5	100	nA	V _{RWM} = 5V
Clamping Voltage	V _{CL}	-	-	10		$I_{PP} = 1A$, $t_p = 8/20 \mu S$
		-	-	14		$I_{PP} = 12A, t_p = 8/20 \mu S$
Breakdown Voltage	V_{BR}	5.5	-	9.5	V	I _R = 1mA
Differential Resistance	R _{DIF}	-	0.4	-	Ω	$I_R = 10A$, $t_p = 8/20 \mu S$
Channel Input Capacitance	C _T	-	35	45	pF	$V_R = 0V$, $f = 1MHz$

Notes:

- 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com.

 6. Short duration pulse test used to minimize self-heating effect.



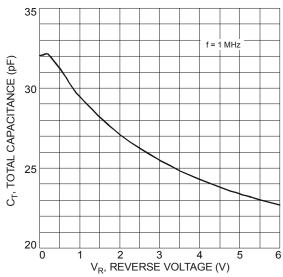
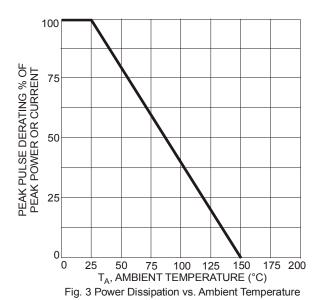
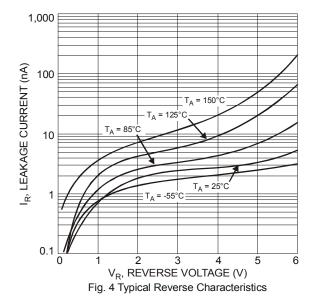


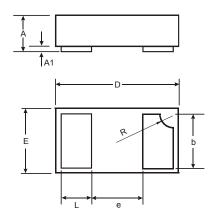
Fig. 2 Typical Total Capacitance vs. Reverse Voltage





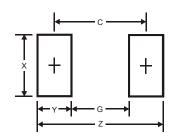


Package Outline Dimensions



X1-DFN1006-2					
Dim	Min	Max	Тур		
Α	0.47	0.53	0.50		
A1	0	0.05	0.03		
b	0.45	0.55	0.50		
D	0.95	1.075	1.00		
Е	0.55	0.675	0.60		
е	-	-	0.40		
L	0.20	0.30	0.25		
R	0.05	0.15	0.10		
All Dimensions in mm					

Suggested Pad Layout



Dimensions	Value (in mm)
Z	1.1
G	0.3
Х	0.7
Y	0.4
С	0.7



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